

Product Brief







EGBL



EGBN

Micross EGB converters offer state of the art performance and is specifically designed for RF GaN SSPA applications. The EGB provides excellent efficiency and low CE, and can be tailored to the specific spacecraft bus and equipment requirements.

RAD-HARD, ITAR FREE 100 kRad and 60 MeV

FEATURES

Electrical Performance

- · Centralized EPC for RF Transmitters
- · Designed for Cold Redundant RF-Systems
- · Output OR-ing and Output Over-Voltage Protection
- · User Adjustable Voltage for Output 1
- · Output ON/OFF Sequencing
- $\cdot~$ WC EOL Output Voltage Accuracy: $\pm~2\%$ Including Line and Load
- · Load Step Transient Response: ± 5% for a 50% to 100% Load Step

Mechanical

 PCB Outline Excl. Connectors
 Mass

 EGBN: 124.2mm x 84.7mm x 23.6mm
 < 225g</td>

 EGBL: 155mm x 70mm x 23.5mm
 < 250g</td>

 EGB: 153mm x 95mm x 25.0mm
 < 300g</td>

Output CE:

V1 and V2: < 10.0mVrms (50Hz to 50MHz) V3 and V4: < 1.0mVrms (50Hz to 50MHz)

CS Rejection Input to Outputs:

V1 and V2: > 40dB V3 and V4: > 85dB

Output Configurations

Output 1: +30V to +60V 180W max

Output 2: +2.5V to +15V 1A or 6W max

Output 3: -2.5V to -15V 1A or 5W max

BENEFITS

Standard Form-Factors, Tailored to Spec

- · Fully Customizable to Match Satellite Platform and Payload Requirements
- · Outputs Can Be Configured to Customer Specifications
- · One High Efficiency Main Output + Two Low Noise Auxiliary Outputs
- · On-Board EMC Filters Ensures Compliance Without Additional Filtering
- · Input to Output Power Efficiency of up to 93%
- · Design Data Package & Product Control Documentation Available

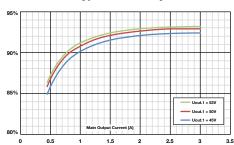
Design Expertise

Our team helps review and specify payload specifics DC-DC converters to ensure maximum compatibility and minimum risk at equipment level. We design, develop, manufacture and test complete DC-DC solutions for effortless payload integration.

Rapid Delivery for Tailored Designs:

- · 6 Months for Engineering Models
- $\cdot~$ 9 Months for CDR Data Package
- · 12 Months for Flight Units

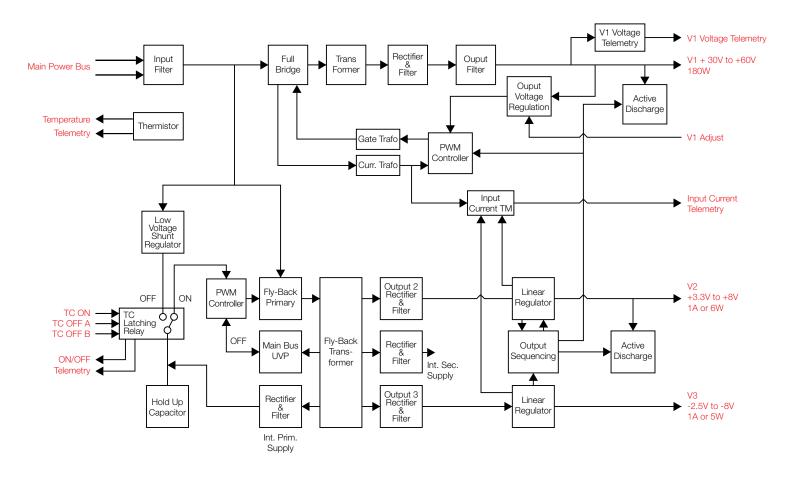
Typical Efficiency



All 4 Outputs Loaded Equal Relative to Max Load

EGB Series

GENERIC BLOCK SCHEMATIC



Flight Qualified and Export Approved Configurations					
Series	Part #	Input Voltage	V1	V2	V3
EGBN	12177	95V - 103V	42.0V / 1.87A	5.0V / 0.20A	-5.0V / 0.13A
EGBL	12123	32V - 37.5V	53.0V / 3.50A	5.0V / 0.20A	-5.0V / 0.13A
	12202	33.1V - 37V	53.0V / 3.00A	5.2V / 0.40A	-5.2V / 0.13A
EGB	12161	98V - 101V	53.0V / 3.50A	5.0V / 0.20A	-5.0V / 0.13A
	12194	98V - 101V	42.0V / 3.81A	5.0V / 0.31A	-5.0V / 0.13A
	12196	22V - 35V	45.0V / 2.20A	8.0V / 0.70A	-6.0V / 0.10A

ECCN: 9A515.y.1

About Micross

Micross is the most complete provider of advanced microelectronic services and component, die and wafer solutions. With the broadest authorized access to die & wafer suppliers, an extensive portfolio of hi-rel power, RF, optoelectronics, memory, data bus, logic, and SMD/5962 qualified products, and the most comprehensive advanced packaging, assembly, modification, upscreening, and test capabilities, Micross is uniquely positioned to provide unparalleled high-reliability solutions, from bare die, to fully packaged devices including hermetic ICs/MCMs, PEMs, ASICs, FPGAs, and PCBs, to complete program life-cycle sustainment. For more than 45 years, Micross has been a trusted source for the aerospace, defense, space, medical, energy, communications, and industrial markets.



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